Multicore SDK (MCSDK) v2.2.0 Release Notes

1 Overview

These are the release notes for the NXP Multicore Software Development Kit (MCSDK) version 2.2.0. This software package contains components for efficient work with multicore devices as well as for the multiprocessor communication.

2 What is new

- New RPMsg-Lite Zero Copy (RPMsgZC) transport layer implemented in eRPC
- Support for the multi-instance in RPMsg-Lite
- Supported evaluation boards (multicore examples):
 - LPCXpresso54114
- Supported evaluation boards (multiprocessor examples):
 - FRDM-K22F
 - FRDM-K28F
 - FRDM-K64F
 - FRDM-K66F
 - FRDM-K82F
 - FRDM-KL25Z
 - FRDM-KL27Z
 - FRDM-KL43Z

Contents

1	Overview	1
2	What is new	1
3	Development tools	2
4	Release contents	2
5	Multicore SDK release overview	2
6	Demo applications	2
7	Revision history	2



Development tools

The Multicore SDK (MCSDK) version 2.2.0 was compiled and tested with these development tools:

- · MCUXpresso IDE
- IAR Embedded Workbench for ARM® version 7.80.4
- MDK-ARM Microcontroller Development Kit (Keil)[®] version 5.21a

Release contents

This table describes the release contents. Not all MCUXpresso SDK packages contain the whole set of these components.

Table 1. Release contents

Deliverable	Location	
Multicore SDK location within the MCUXpresso SDK folder structure	<mcuxpressosdk_install_dir>/middleware/multicore_<version>/</version></mcuxpressosdk_install_dir>	
Documentation	<mcuxpressosdk_install_dir>/docs/multicore/</mcuxpressosdk_install_dir>	
Embedded Remote Procedure Call component	<mcsdk_dir>/erpc/</mcsdk_dir>	
Multicore Manager component	<mcsdk_dir>/mcmgr/</mcsdk_dir>	
RPMsg-Lite	<mcsdk_dir>/rpmsg_lite/</mcsdk_dir>	
Multicore demo applications	<mcuxpressosdk_install_dir>/boards/<board_name>/ multicore_examples/</board_name></mcuxpressosdk_install_dir>	
Multiprocessor demo applications	<mcuxpressosdk_install_dir>/boards/<board_name>/ multiprocessor_examples/</board_name></mcuxpressosdk_install_dir>	

Multicore SDK release overview 5

Together, the Multicore SDK (MCSDK) and the MCUXpresso SDK (SDK) form a framework for the development of software for NXP multicore devices. The MCSDK release consists of the following elementary software components for multicore:

- Embedded Remote Procedure Call (eRPC)
- Multicore Manager (MCMGR) included just in SDK for multicore devices
- Remote Processor Messaging Lite (RPMsg-Lite) included just in SDK for multicore devices

The MCSDK is also accompanied with documentation and several multicore and multiprocessor demo applications.

Demo applications

Multicore SDK (MCSDK) v2.2.0 Release Notes, Rev. 4, 03/2017 NXP Semiconductors The multicore demo applications demonstrate the usage of the MCSDK software components on supported multicore development boards. The following multicore demo applications are located together with other MCUXpresso SDK examples in the *ACUXpressoSDK_install_dir>/boards/
-board_name>/multicore_examples...* subdirectories.

- erpc_matrix_multiply
- erpc_matrix_multiply_rtos
- hello_world
- low_power
- rpmsg_lite_pingpong
- rpmsg_lite_pingpong_rtos

The eRPC multicore component can be leveraged for inter-processor communication and remote procedure calls between SoCs / development boards. The following multiprocessor demo applications are located together with other MCUXpresso SDK examples in the <mcutaevalue /mcuxpressoSDK_install_dir>/boards/

board_name>/multiprocessor_examples... subdirectories.

- erpc_client_matrix_multiply_spi
- erpc_server_matrix_multiply_spi
- erpc_client_matrix_multiply_uart
- erpc_server_matrix_multiply_uart
- erpc_server_dac_adc
- erpc_remote_control

7 Revision history

This table summarizes revisions to this document.

Table 2. Revision History

Revision number	Date	Substantive changes
0	09/2015	Initial release
1	03/2016	Updated for the KSDK 2.0.0 and the MCSDK 1.1.0
2	08/2016	Updated for the MCSDK 2.0.0 and the LPCXpresso54114 support
3	09/2016	Updated for the MCSDK 2.1.0
4	03/2017	Updated for the MCSDK 2.2.0

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